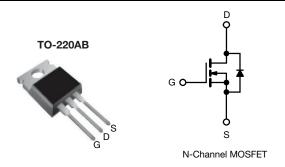


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	250				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V 0.28				
Q _g max. (nC)	68				
Q _{gs} (nC)	11				
Q _{gd} (nC)	35				
Configuration	Single				



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Load (Dh) from	IRF644PbF		
Lead (Pb)-free	SiHF644-E3		
SnPb	IRF644		
SIPO	SiHF644		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	250	V	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		14	А	
Continuous Drain Current		T _C = 100 °C	I _D	8.5		
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	550	mJ	
Repetitive Avalanche Current a			I _{AR}	14	Α	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation	mum Power Dissipation $T_C = 25 ^{\circ}C$			125	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak temperature) d	for	10 s		300		
Mounting Toyana	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=4.5 mH, $R_g=25$ Ω , $I_{AS}=14$ A (see fig. 12). c. $I_{SD}\leq 14$ A, $dI/dt\leq 150$ A/µs, $V_{DD}\leq V_{DS}$, $T_J\leq 150$ °C. d. 1.6 mm from case.



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		250	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.34	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Zava Cata Valtaga Dvain Coverent		V _{DS} = 250 V, V _{GS} = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200 V	V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.4 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 8.4 A ^b	6.7	-	-	S
Dynamic							•
Input Capacitance	C _{iss}		$V_{GS} = 0 V$	-	1300	-	pF
Output Capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	330	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	f = 1.0 MHz, see fig. 5		85	-	'
Total Gate Charge	Qg			-	-	68	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 7.9 \text{ A}, V_{DS} = 200 \text{ V},$ see fig. 6 and 13 b		-	11	
Gate-Drain Charge	Q _{gd}	1			-	35	
Turn-On Delay Time	t _{d(on)}		V _{DD} = 125 V, I _D = 7.9 A,		11	-	- ns
Rise Time	t _r	V _{DD} =			24	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$, $R_D = 8.7 \Omega$, see fig. 10 ^b		-	53	-	
Fall Time	t _f			-	49	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L _S	package and o	package and center of die contact		7.5	-	- nH
Gate Input Resistance	R_g	f = 1 MHz, open drain		0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	56	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V b		-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C '			250	500	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 7.9 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	2.3	4.6	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

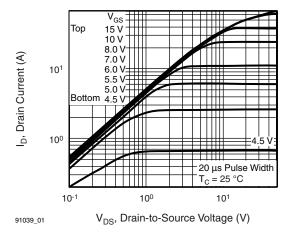


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

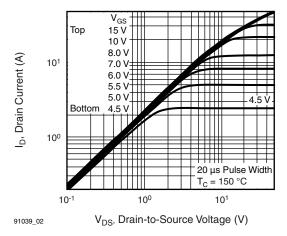


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

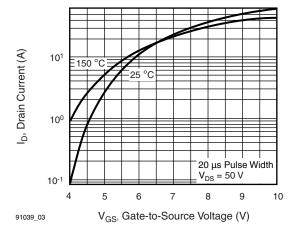


Fig. 3 - Typical Transfer Characteristics

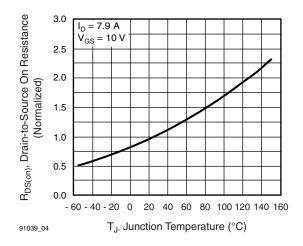


Fig. 4 - Normalized On-Resistance vs. Temperature

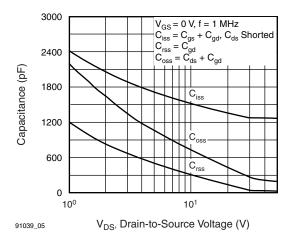


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

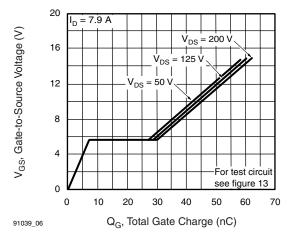


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



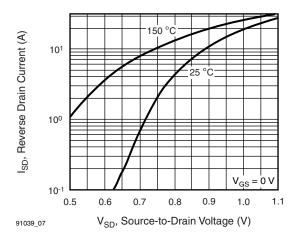


Fig. 7 - Typical Source-Drain Diode Forward Voltage

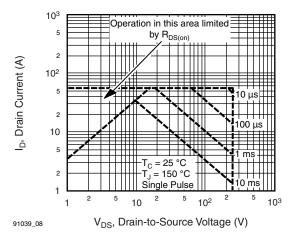


Fig. 8 - Maximum Safe Operating Area

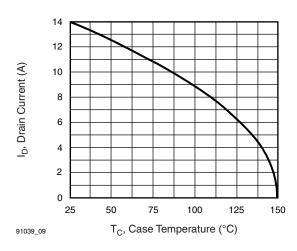


Fig. 9 - Maximum Drain Current vs. Case Temperature

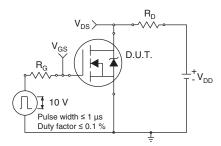


Fig. 10a - Switching Time Test Circuit

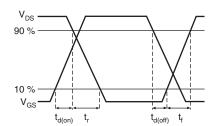


Fig. 10b - Switching Time Waveforms

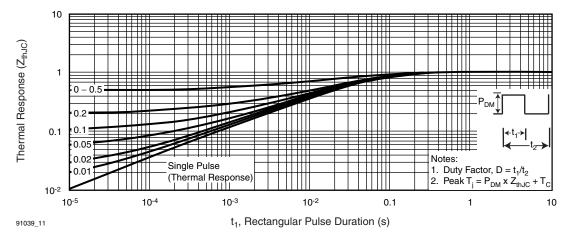
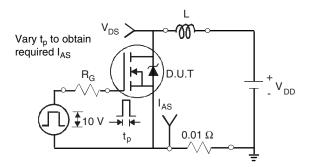


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





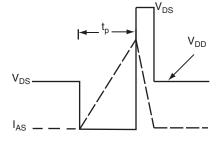


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

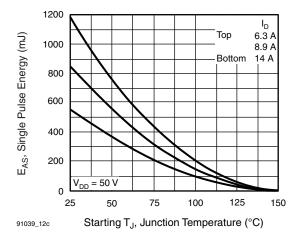


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

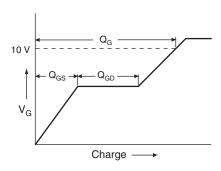


Fig. 13a - Basic Gate Charge Waveform

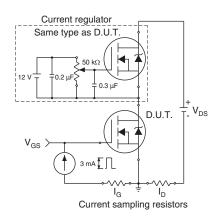
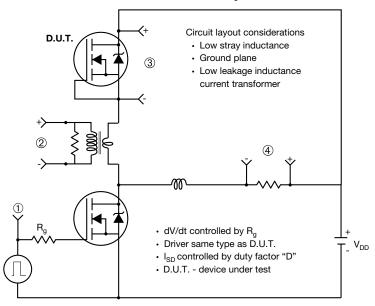


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



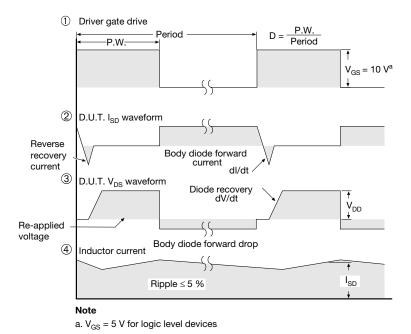


Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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